SCHS314C - MAY 2002 - REVISED MAY 2003

 4.5-V to 5.5-V V_{CC} Operation Fanout (Over Temperature Range) 	E PACKAGE (TOP VIEW)
 Standard Outputs 10 LSTTL Loads Bus-Driver Outputs 15 LSTTL Loads 	$ \begin{array}{c} \overline{LE} \begin{bmatrix} 1 \\ 2 \end{bmatrix} & \begin{array}{c} 24 \\ 2 \end{bmatrix} \\ \overline{LE} \end{bmatrix} \\ \begin{array}{c} V_{CC} \\ Z_{CC} \end{bmatrix} \\ \overline{E} \end{bmatrix} $
 Wide Operating Temperature Range of –55°C to 125°C 	A1 3 22 A3 Y7 4 21 A2
 Balanced Propagation Delays and 	Y6 5 20 Y10
 Transition Times Significant Power Reduction Compared to 	Y5 [] 6 19 [] Y11 Y4 [] 7 18 [] Y8
LSTTL Logic ICs	Y3 8 17 Y9 Y1 9 16 Y14
 HCT Types Direct LSTTL Input Logic Compatibility, 	Y2 10 15 Y15
V _{IL} = 0.8 V (Max), V _{IH} = 2 V (Min)	Y0 11 14 Y12 GND 12 13 Y13
 CMOS Input Compatibility, I_I ≤ 1 μA at V_{OL}, V_{OH} 	····· •

description/ordering information

The CD74HCT4514 and CD74HCT4515 are high-speed silicon-gate devices consisting of a 4-bit strobed latch and a 4-line to 16-line decoder. The selected output is enabled by a low on the enable (\overline{E}) input. A high on \overline{E} inhibits selection of any output. Demultiplexing is accomplished by using \overline{E} as the data input and the select inputs (A0–A3) as addresses. \overline{E} also serves as a chip select when these devices are cascaded.

When the latch enable ($\overline{\text{LE}}$) is high, the output follows changes in the inputs (see decode function table). When $\overline{\text{LE}}$ is low, the output is isolated from changes in the input and remains at the level (high for the '4514, low for the '4515) it had before the latch was enabled.

TA	PAC	KAGE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	PDIP – F	Tube	CD74HCT4514E	CD74HCT4514E
-33 C to 123 C	10 125°C PDIP - E	Tube	CD74HCT4515E	CD74HCT4515E

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



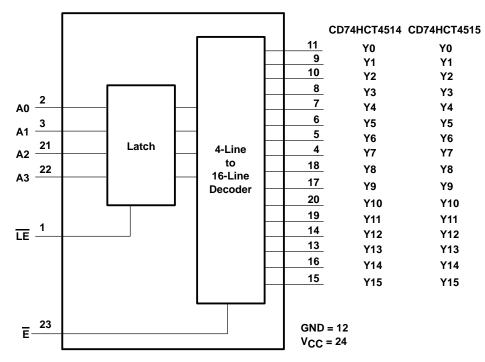
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SCHS314C - MAY 2002 - REVISED MAY 2003

DECODE F <u>UN</u> CTION TABLE (LE = H)								
-	D	ECODE	r input	S	ADDRESSED OUTPUT			
E	A3	A2	A1	A0	CD74HCT4514 = H CD74HCT4515 = L			
L	L	L	L	L	Y0			
L	L	L	L	Н	Y1			
L	L	L	Н	L	Y2			
L	L	L	Н	Н	Y3			
L	L	Н	L	L	Y4			
L	L	Н	L	Н	Y5			
L	L	Н	Н	L	Y6			
L	L	Н	Н	Н	Y7			
L	н	L	L	L	Y8			
L	н	L	L	Н	Y9			
L	н	L	Н	L	Y10			
L	н	L	Н	Н	Y11			
L	н	Н	L	L	Y12			
L	н	Н	L	Н	Y13			
L	н	Н	Н	L	Y14			
L	н	Н	Н	Н	Y15			
н	х	х	х	х	All outputs = L, CD74HCT4514 All outputs = H, CD74HCT4515			

H = high, L = low, X = don't care

logic diagram (positive logic)





SCHS314C - MAY 2002 - REVISED MAY 2003

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} . Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) Continuous output drain current per output, I_O ($V_O = 0$ to V_{CC}) Continuous output source or sink current per output, I_O ($V_O = 0$ to V_{CC}) Continuous current through V_{CC} or GND Package thermal impedance, θ_{JA} (see Note 2) Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-3.

recommended operating conditions (see Note 3)

		T _A = 25°C		T _A = −55°C TO 125°C		T _A = −40°C TO 85°C		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
Vcc	Supply voltage	4.5	5.5	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		2		V
VIL	Low-level input voltage		0.8		0.8		0.8	V
VI	Input voltage	0	VCC	0	VCC	0	VCC	V
Vo	Output voltage	0	VCC	0	VCC	0	VCC	V
$\Delta t/\Delta v$	Input transition rise or fall rate		500		500		500	ns

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER TEST CONDITIONS		TEST CONDITIONS V _{CI}		T _A =	25°C	T _A = - TO 12		T _A = - TO 8		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
Vou	VI = VIH or VIL	I _{OH} = -20 μA	4.5 V	4.4		4.4		4.4		V
VOH		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98		3.7		3.84		v
Vei	VI = VIH or VIL	I _{OL} = 20 μA	4.5 V		0.1		0.1		0.1	V
VOL		$I_{OL} = 4 \text{ mA}$	4.5 V		0.26		0.4		0.33	v
lj	VI = ACC or 0		5.5 V		±0.1		±1		±1	μA
Icc	$V_I = V_{CC} \text{ or } 0,$	IO = 0	5.5 V		8		160		80	μA
∆lCC‡	One input at V _{CC} – 2.1 V,	Other inputs at 0 or V _{CC}	4.5 V to 5.5 V		360		490		450	μA
Ci					10		10		10	pF

[‡]Additional quiescent supply current per input pin, TTL inputs high, 1 unit load. For dual-supply systems, theoretical worst-case ($V_I = 2.4 \text{ V}, V_{CC} = 5.5 \text{ V}$) specification is 1.8 mA.



SCHS314C - MAY 2002 - REVISED MAY 2003

HCT INPUT LOADING TABLE

INPUT	UNIT LOAD					
A0–A3	0.15					
LE	0.85					
Ē	0.3					
Unit load specified	is ∆I _{CC} limit in electrical					

characteristics table (e.g., $360 \ \mu A \ max at 25^{\circ}C$).

timing requirements over recommended operating free-air temperature range, V_{CC} = 4.5 V, C_L = 15 pF (unless otherwise noted) (see Figure 1)

		T _A = 2	$T_{A} = 25^{\circ}C \qquad \begin{array}{c} T_{A} = -55^{\circ}C \\ TO \ 125^{\circ}C \end{array}$		T _A = −40°C TO 85°C		UNIT	
		MIN	MAX	MIN	MAX	MIN	MAX	
tw	Pulse duration, LE high	30		45		38		ns
t _{su}	Setup time, data before $\overline{LE}\downarrow$	20		30		25		ns
t _h	Hold time, data after $\overline{\text{LE}}\downarrow$	5		5		5		ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 4.5 V (unless otherwise noted) (see Figure 1)

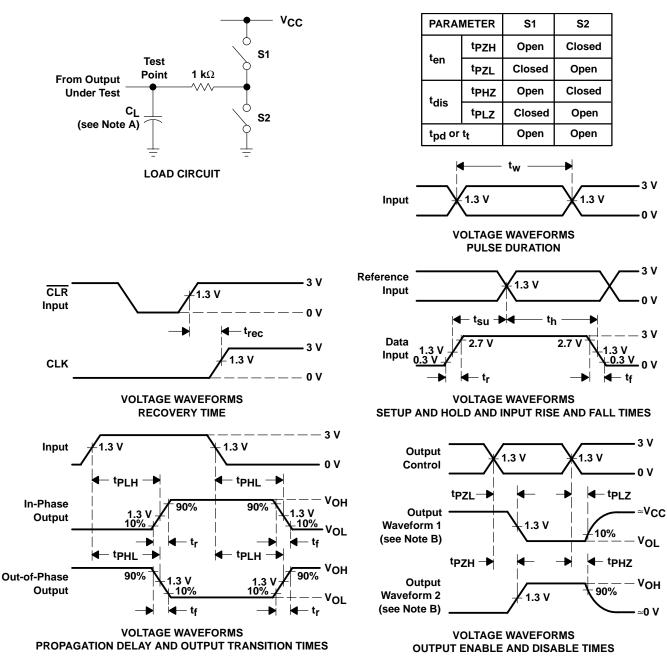
PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 2	25°C	T _A = - TO 12		T _A = - TO 8		UNIT											
		(001101)	CALACITANCE	CALACITANCE	CALACITANCE	MIN	MAX	MIN	MAX	MIN	MAX										
	A0–A3				55		83		69												
^t pd	LE	Y	C _L = 50 pF		50		75		63	ns											
	Ē															40		60		50	
tt		Y	C _L = 50 pF		15		22		19	ns											

operating characteristics, V_{CC} = 5 V, T_A = 25° C

PARAMETER	TYP	UNIT
C _{pd} Power dissipation capacitance	75	pF

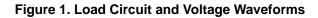


SCHS314C - MAY 2002 - REVISED MAY 2003



PARAMETER MEASUREMENT INFORMATION

- NOTES: A. CL includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following
 - characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_r = 6 ns. t_f = 6 ns.
 - D. For clock inputs, f_{max} is measured with the input duty cycle at 50%.
 - E. The outputs are measured one at a time with one input transition per measurement.
 - F. tpLz and tpHz are the same as tdis.
 - G. t_{PZL} and t_{PZH} are the same as t_{en} .
 - H. tpLH and tpHL are the same as t_{pd} .



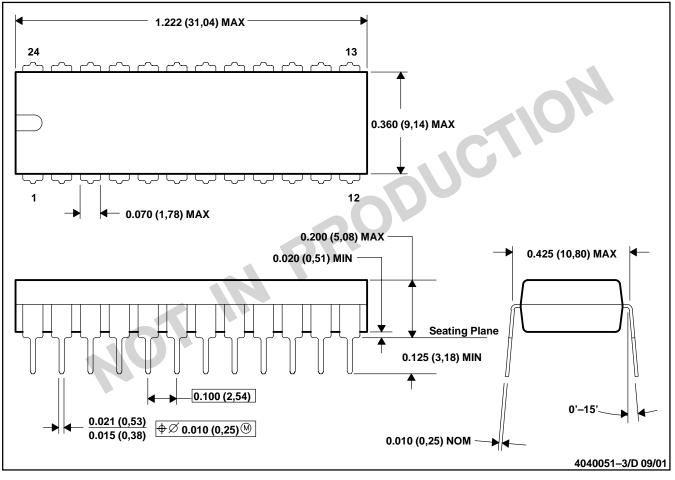


MECHANICAL DATA

MPDI006B - SEPTEMBER 2001 - REVISED APRIL 2002

N (R-PDIP-T24)

PLASTIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-010



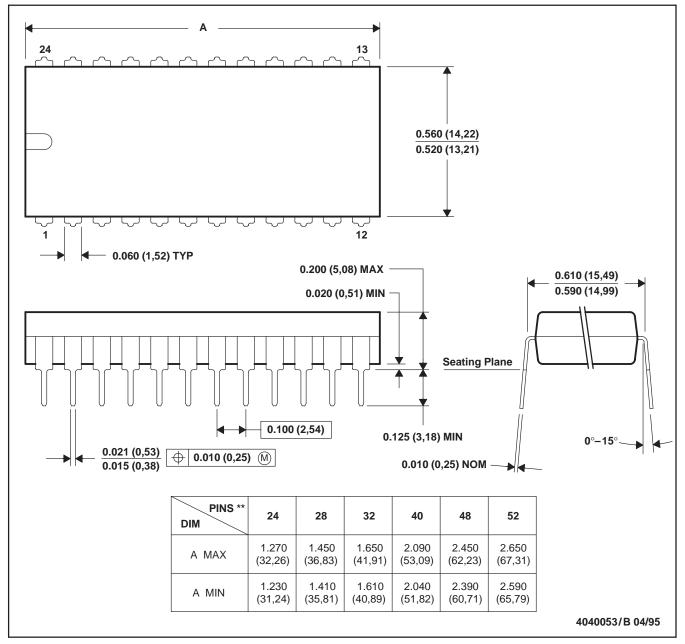
MECHANICAL DATA

MPDI008 - OCTOBER 1994

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-011
- D. Falls within JEDEC MS-015 (32 pin only)



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